

ASUSTeK COMPUTER INC.

1F., No. 15, Lide Rd., Beitou, Taipei City 112, Taiwan

Class II Change Letter

Date: 2024/4/24

Federal Communications Commission
7435 Oakland Mills Road
Columbia MD 21046
To Whom It May Concern:
Request for Class II Permissive Change

FCC ID: MSQ-RTAX5X00 / Grant Date: 10/28/2022

Pursuant to CFR 2.1043, ASUSTeK COMPUTER INC. hereby requests a Class II Permissive Change.

Modification:

1. Add the EUT 3 for the device as below.

EUT	PCB board Version	MLCC - SMD/SMT	Resistance - SMD/SMT	Color of outer case and heatsink	
		Location: CB293, CB296, CB299, CB302 Description : MLCC 1PF/25V (0201) NPO 0.1PF	Location: RB58, RB75, RB91, RB107 Description : RES 0 OHM 1/20W (0201) JUMP	Black outer case	White outer case
EUT 1	R1.20	Brand : MURATA	Brand : TA-I	With silver heatsink	With silver heatsink
EUT 2	R2.00	Model : GRM0335C1E1R0BA01D	Brand : RM02JTN0	With silver heatsink	With silver heatsink
EUT 3	R2.00	Brand : DARFON Model : C0603NP0109BFT	Brand : WALSIN Brand : WR02X000PAL	With black heatsink	With silver heatsink

Based on R1.20, there's a little bit change that is R2.00.
(a.) Mainboard: Adding common mode filter to TX path of USB3.0 (Location: FL1).
(b.) I/O board: Adding common mode filter to RX path of USB3.0 (Location: FL3).

2. Remove the manufacturer information of the test reports.

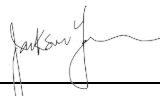
Note: There is no software that can be modified by end-user.

Respectfully,

Applicant's company name : ASUSTeK COMPUTER INC.

Applicant's company address : 1F., No. 15, Lide Rd., Beitou, Taipei City 112, Taiwan

Signature :



Name and Job Title : Jackson Yen / Associate Vice President

E-Mail : Jackson_Yen@asus.com

Tel : (886)2-2894-3447

Fax : (886)2-2898-7364